

HSF

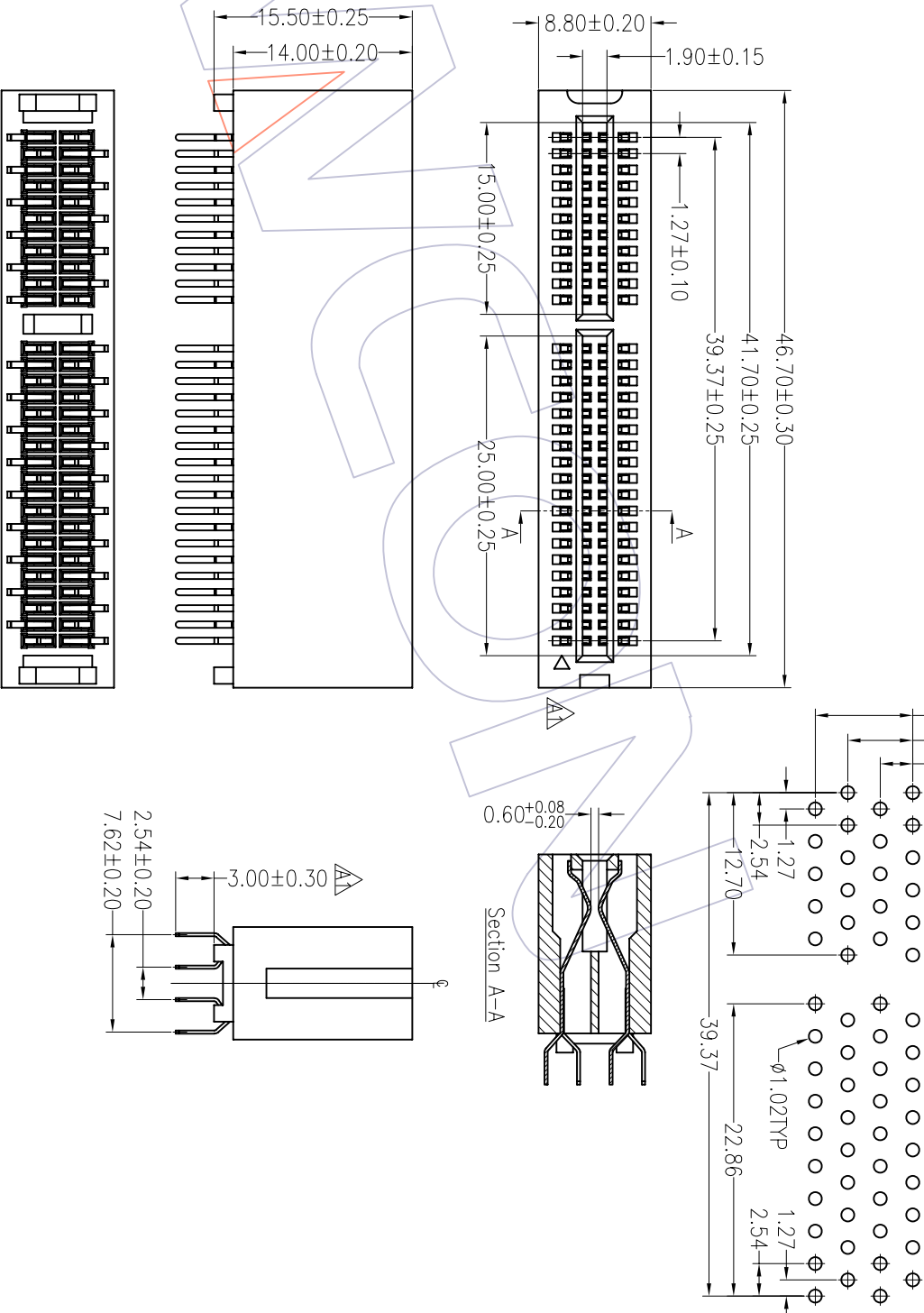
NOTES:

Current Rating: 1.0AMP
Contact Resistance: 30mΩ max
Withstand Voltage: 500V AC/DC
Insulation Resistance: 1000MΩ min
Operation Temperature: -40°C to +105°C
Contact Material: Brass
Contact plating: Au or Sn Over Ni
Insulator Material: PA66+30%G.F

Ordering Information

7510-060 S X N B 01

60Pin 180° DIP Color:
B=Black
W=White
U=Blue
Y=Yellow
R=Red
G=Grey
Insulator:
B=PA66



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

| REV | DATE | MODIFICATION DESCRIPTION | CHANGE | APPROVE | OPERATION | DRAW | SCALE | PART NO. | TITLE: |
|-----|----------|--------------------------|--------|---------|----------------|---------------------|-------|-----------------|-------------------------|
| A1 | 08/08/07 | 变更DIP脚长度和三角符号位置 | | | X.X ±0.40 | William 08.08.07 | 1:1 | 7510-060SXXNB01 | PCI Slot 60Pin DIP Type |
| A0 | 08/05/26 | NEW | | | X.XX ±0.25 | DESIGN | mm | | |
| | | | | | X.XXX ±0.15 | CHECK | A4 | | |
| | | | | | Angle ± 3' | APPROVE | 1/1 | | |
| | | | | | DIM TOL | | PROJ. | Customer NO. | |

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